

ABSTRACT

An electronic component including, on one surface of a substrate (1), a plurality of circuit elements and external terminals each consisting of a conductive protrusion (9) for the circuit elements is provided with a structure capable of resisting an external force after mounting. Each of the circuit elements includes, as constituent elements, a pair of electrodes (2) and a resistive element (3) or a dielectric contacting with the pair of electrodes (2), each circuit element is covered with an overcoat (7) while the electrodes (2) are partially exposed as lands (4), the conductive protrusion (9) includes a fixedly bonding member, the conductive protrusion (9) is fixedly bonded to each of the lands (4) by the fixedly bonding member, at least three lands (4b) of the lands (4) are larger in area than the other lands (4a), the electronic component can stand alone while the conductive protrusion (9) contacts with a flat if the conductive protrusion (9) is fixedly bonded only to each of the larger-area lands (4b), and the conductive protrusions are all formed by fixedly bonding conductive balls (10) substantially equal in size to entire surfaces of the respective lands (4).